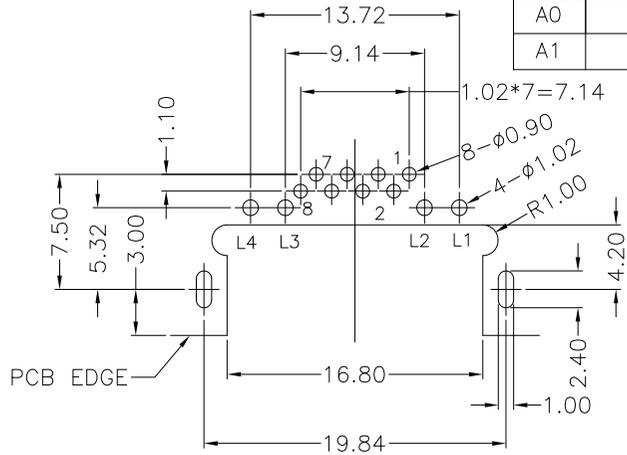
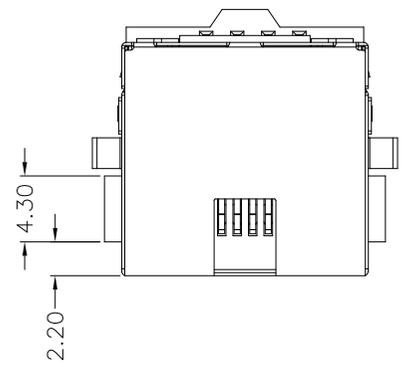


GP Component

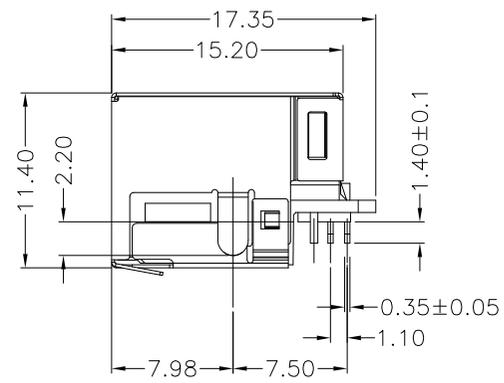
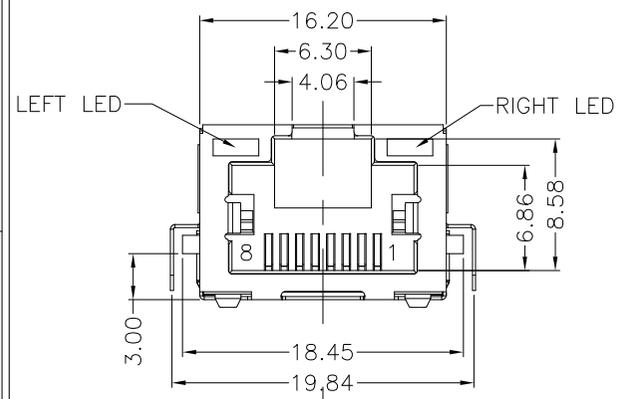
REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2018/05/28	Phebe Su
A1			Change	2018/05/29	Phebe Su



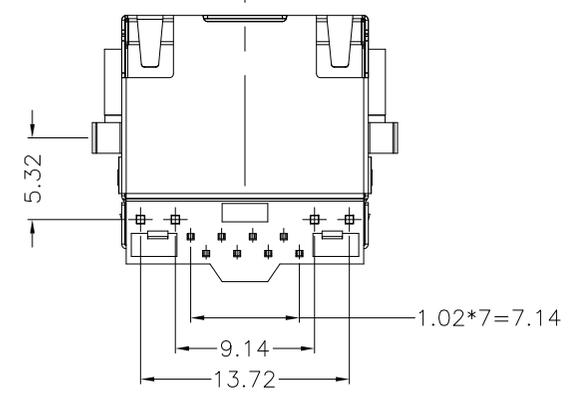
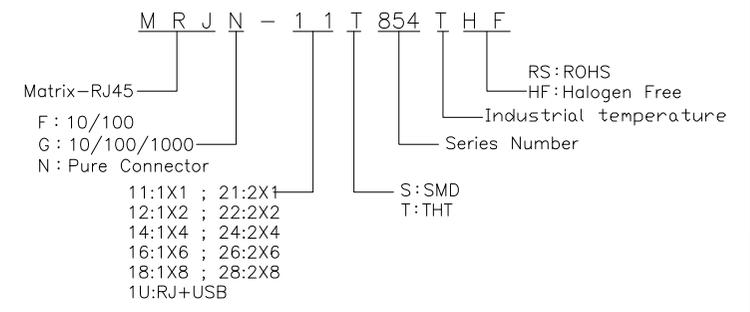
RECOMMENED PCB LAYOUT
COMPONENT SIDE
TOLERANCE ±0.05

NOTES:

- MATERIALS:
HOUSING: LCP, BLACK UL94V-0,
CONTACTS: PHOSPHOR BRONZE T=0.35
GOLD FLASH ON CONTACT AREA
SHIELD: COPPER ALLOY, 30u" NICKEL PLATING OVERALL
- OPERATING TEMPERATURE: -40°C ~ +85°C
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F



ORDER INFORMATION :



NO	VARIETY	QTY	MATERIAL	REMARK
 Matrix Electronics Co.,Ltd				
TOLERANCE: X.X ±0.38 X.XX ±0.25 X.XXX ±0.13 ANGLE: ±3°		DESIGN BY : Phebe Su DATE : 2018/05/29		PART NAME: RJ45 CONN 1X1 BOTTOM CONNNECTOR W/LED, 8P8C
CHECKED BY: Vicky Hsieh		DATE : 2018/05/29		PART NO. MRJN-11T854THF
APPROVED BY1: Richard Hsieh		DATE : 2018/05/29		MOLD NO. NA
APPROVED BY2: Richard Hsieh		DATE : 2018/05/29		DRAW NO. SHEET NO. 1 OF 1
UNIT: mm [inch] SCALE:1:1 SIZE:A4				